
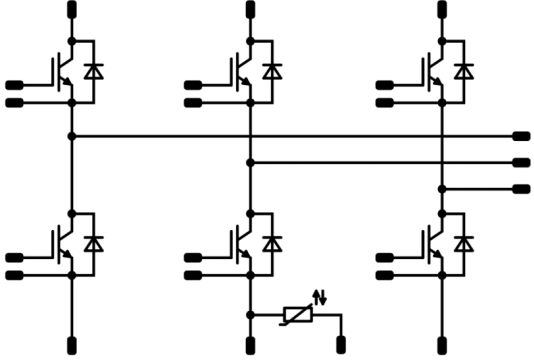




Vincotech

<i>flow</i> PACK 2	1200 V / 100 A
<div style="background-color: #eee; padding: 2px; border: 1px solid #ccc; margin-bottom: 5px;">Features</div> <ul style="list-style-type: none"> IGBT4 (1200 V) technology for low saturation losses and improved EMC behavior Compact and low inductive design Integrated temperature sensor 	<div style="background-color: #eee; padding: 2px; border: 1px solid #ccc; margin-bottom: 5px;"><i>flow</i> 2 17 mm housing</div> 
<div style="background-color: #eee; padding: 2px; border: 1px solid #ccc; margin-bottom: 5px;">Target applications</div> <ul style="list-style-type: none"> Industrial Drives 	<div style="background-color: #eee; padding: 2px; border: 1px solid #ccc; margin-bottom: 5px;">Schematic</div> 
<div style="background-color: #eee; padding: 2px; border: 1px solid #ccc; margin-bottom: 5px;">Types</div> <ul style="list-style-type: none"> 30-P2126PA100SC-L289F09Y 	

Maximum Ratings

$T_j = 25\text{ °C}$, unless otherwise specified

Parameter	Symbol	Condition	Value	Unit
Inverter Switch				
Collector-emitter voltage	V_{CES}		1200	V
Collector current	I_C	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	116	A
Repetitive peak collector current	I_{CRM}	t_p limited by T_{jmax}	300	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	307	W
Gate-emitter voltage	V_{GES}		± 20	V
Short circuit ratings	t_{SC}	$T_j \leq 150\text{ °C}$	10	μs
	V_{CC}	$V_{GE} = 15\text{ V}$	800	V
Maximum Junction Temperature	T_{jmax}		175	°C



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Maximum Ratings

$T_j = 25\text{ °C}$, unless otherwise specified

Parameter	Symbol	Condition	Value	Unit
Inverter Diode				
Peak Repetitive Reverse Voltage	V_{RRM}		1200	V
Continuous (direct) forward current	I_F	$T_j = T_{jmax}$ $T_s = 80\text{°C}$	96	A
Repetitive peak forward current	I_{FRM}		200	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80\text{°C}$	176	W
Maximum Junction Temperature	T_{jmax}		175	°C

Module Properties

Thermal Properties

Storage temperature	T_{stg}		-40...+125	°C
Operation temperature under switching condition	T_{jop}		-40...(T _{jmax} - 25)	°C

Isolation Properties

Isolation voltage	V_{isol}	DC Test Voltage* $t_p = 2\text{ s}$	4000	V
		AC Voltage $t_p = 1\text{ min}$	2500	V
Creepage distance			min. 12,7	mm
Clearance			min. 12,7	mm
Comparative Tracking Index	CTI		> 200	

*100 % tested in production



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Characteristic Values

Parameter	Symbol	Conditions					Value			Unit
		V_{GS} [V]	V_{GE} [V]	V_{DS} [V]	I_D [A]	T_j [°C]	Min	Typ	Max	

Inverter Switch

Static

Parameter	Symbol	Conditions	V_{GS} [V]	V_{GE} [V]	V_{DS} [V]	I_D [A]	T_j [°C]	Min	Typ	Max	Unit
Gate-emitter threshold voltage	$V_{GE(th)}$	$V_{GE} = V_{CE}$				0,0034	25	5,3	5,8	6,3	V
Collector-emitter saturation voltage	V_{CEsat}		15			100	25 150	1,58	1,88 2,30	2,07	V
Collector-emitter cut-off current	I_{CES}		0	1200			25			2	μA
Gate-emitter leakage current	I_{GES}		20	0			25			240	nA
Internal gate resistance	r_g								2		Ω
Input capacitance	C_{ies}	$f = 1$ MHz	0	25			25		5600		pF
Reverse transfer capacitance	C_{res}								200		

Thermal

Parameter	Symbol	Conditions	Value	Unit
Thermal resistance junction to sink	$R_{th(j-s)}$	phase-change material $\lambda = 3,4$ W/mK	0,31	K/W

Dynamic

Parameter	Symbol	Conditions	V_{GS} [V]	V_{GE} [V]	V_{DS} [V]	I_D [A]	T_j [°C]	Min	Typ	Max	Unit
Turn-on delay time	$t_{d(on)}$	$R_{goff} = 4 \Omega$ $R_{gon} = 4 \Omega$	± 15	600	100	100	25		104		ns
Rise time	t_r							25	18		
Turn-off delay time	$t_{d(off)}$							150	23		
Fall time	t_f							25	219		
Turn-on energy (per pulse)	E_{on}							150	293		
Turn-off energy (per pulse)	E_{off}							25	72		
		150	111								
		25	4,040								
		150	6,729								
		25	5,249								
		150	8,769								



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Characteristic Values

Parameter	Symbol	Conditions					Value			Unit
		V_{GE} [V]	V_{CE} [V]	I_C [A]	T_j [°C]	Min	Typ	Max		

Inverter Diode

Static

Parameter	Symbol	V_{GS} [V]	V_{DS} [V]	I_D [A]	I_F [A]	T_j [°C]	Min	Typ	Max	Unit
Forward voltage	V_F			100		25 125	1,35	1,83 1,86	2,05	V
Reverse leakage current	I_r		1200			25 150			18	µA

Thermal

Parameter	Symbol	Conditions	Value	Unit
Thermal resistance junction to sink	$R_{th(j-s)}$	phase-change material $\lambda = 3,4$ W/mK	0,54	K/W

Dynamic

Parameter	Symbol	di/dt	\pm	V_{GS}	I_D	T_j [°C]	Min	Typ	Max	Unit
Peak recovery current	I_{RRM}					25 150		164 187		A
Reverse recovery time	t_{rr}					25 150		130 294		ns
Recovered charge	Q_r	$di/dt = 6900$ A/µs $di/dt = 5512$ A/µs	± 15	600	100	25 150		9,320 18,656		µC
Reverse recovered energy	E_{rec}					25 150		3,869 7,956		mWs
Peak rate of fall of recovery current	$(di_{rr}/dt)_{max}$					25 150		8743 3702		A/µs

Thermistor

Parameter	Symbol	Conditions	T_j [°C]	Min	Typ	Max	Unit
Rated resistance	R		25		22		kΩ
Deviation of R_{100}	$\Delta_{R/R}$	$R_{100} = 1486$ Ω	100	-12		+14	%
Power dissipation	P		25		200		mW
Power dissipation constant			25		2		mW/K
B-value	$B_{(25/50)}$	Tol. $\pm 3\%$	25		3950		K
B-value	$B_{(25/100)}$	Tol. $\pm 3\%$	25		3998		K
Vincotech NTC Reference						B	

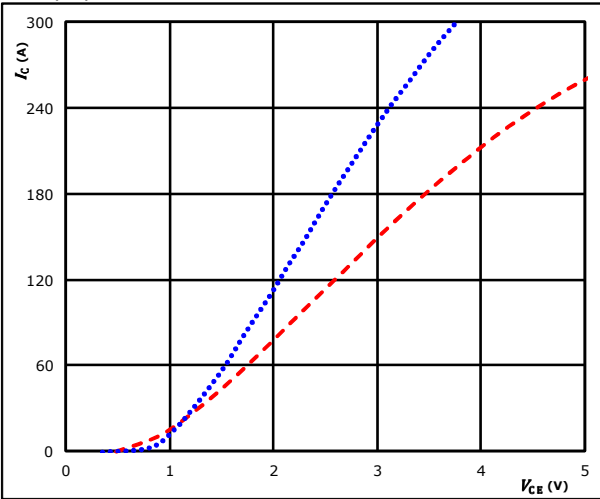


Inverter Switch Characteristics

figure 1. IGBT

Typical output characteristics

$I_C = f(V_{CE})$

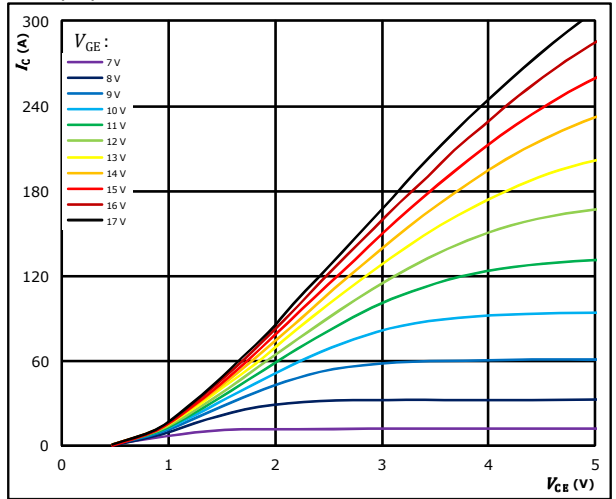


$t_p = 250 \mu s$
 $V_{GE} = 15 V$
 $T_j: 25 \text{ °C}$ (blue dotted line)
 150 °C (red dashed line)

figure 2. IGBT

Typical output characteristics

$I_C = f(V_{CE})$

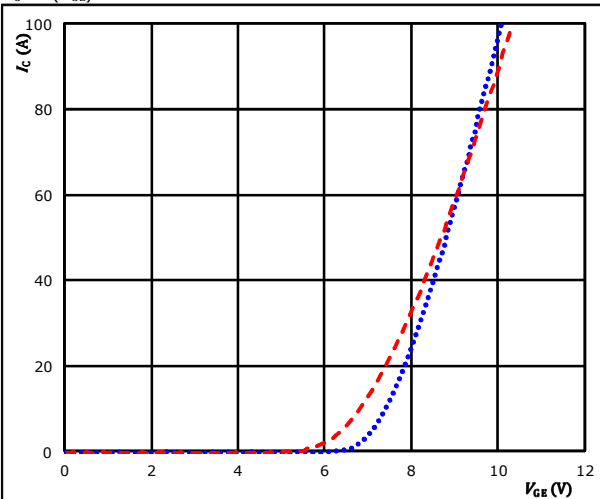


$t_p = 250 \mu s$
 $T_j = 150 \text{ °C}$
 V_{GE} from 7 V to 17 V in steps of 1 V

figure 3. IGBT

Typical transfer characteristics

$I_C = f(V_{GE})$

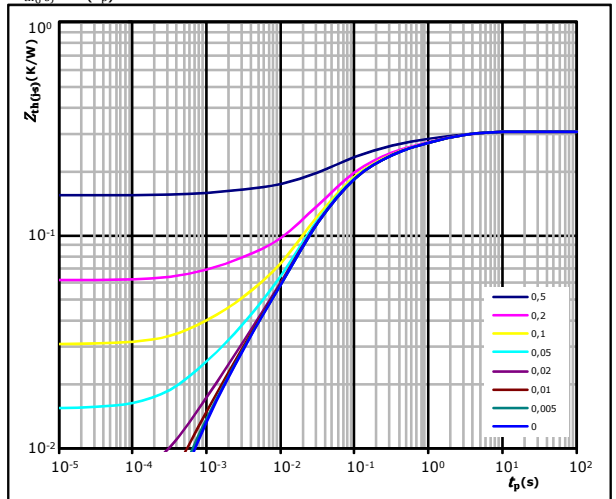


$t_p = 100 \mu s$
 $V_{CE} = 10 V$
 $T_j: 25 \text{ °C}$ (blue dotted line)
 150 °C (red dashed line)

figure 4. IGBT

Transient thermal impedance as function of pulse duration

$Z_{th(j-s)} = f(t_p)$



$D = t_p / T$
 $R_{th(j-s)} = 0,31 \text{ K/W}$
 IGBT thermal model values

R (K/W)	τ (s)
6,00E-02	1,67E+00
7,30E-02	2,35E-01
1,19E-01	5,35E-02
4,31E-02	1,45E-02
1,45E-02	1,21E-03



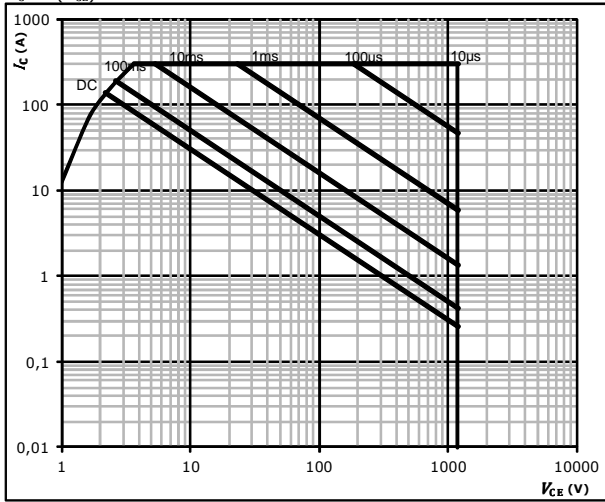
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Inverter Switch Characteristics

figure 5. IGBT

Safe operating area

$$I_C = f(V_{CE})$$



- $D =$ single pulse
- $T_s = 80$ °C
- $V_{GE} = \pm 15$ V
- $T_j = T_{jmax}$



Inverter Diode Characteristics

figure 1. FWD
Typical forward characteristics

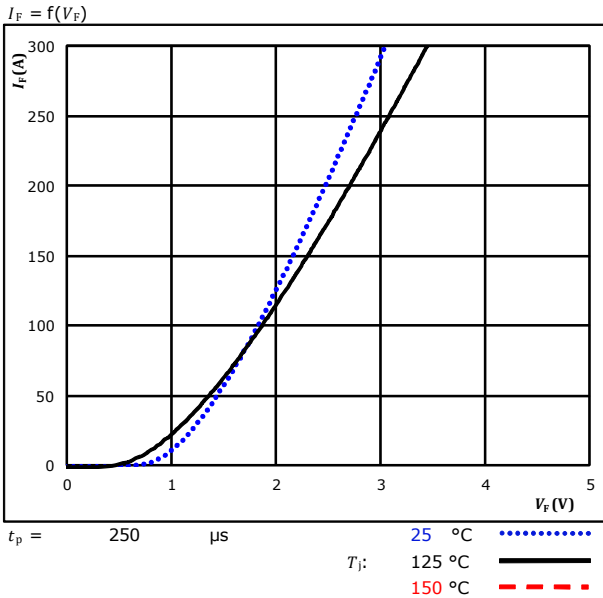
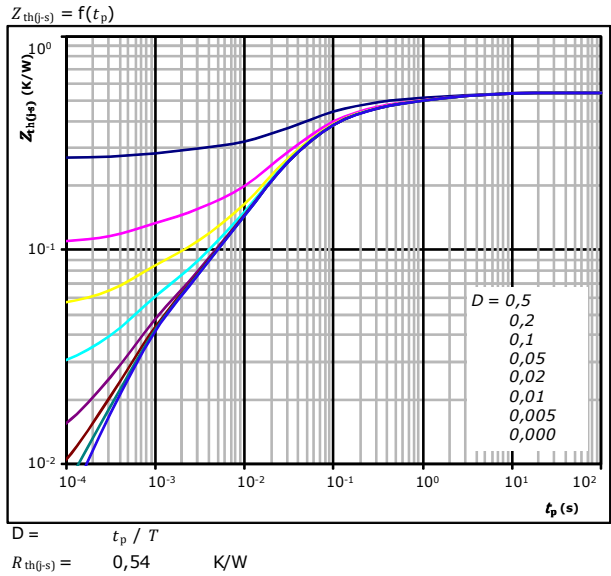


figure 2. FWD
Transient thermal impedance as a function of pulse width

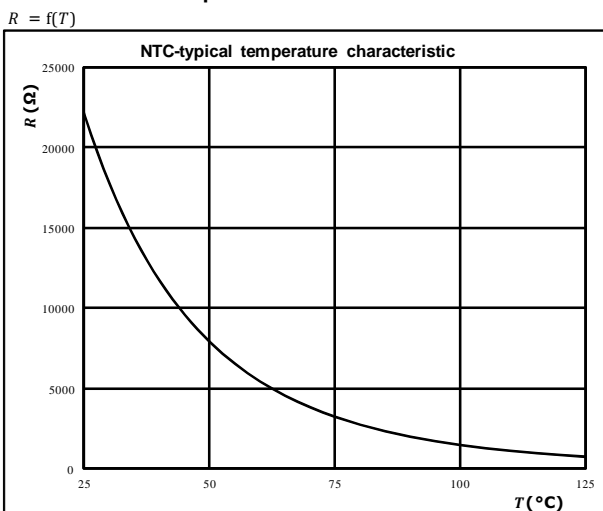


FWD thermal model values

R (K/W)	τ (s)
3,2540E-02	4,1350E+00
5,0100E-02	9,8970E-01
1,3800E-01	1,4500E-01
2,2240E-01	3,3740E-02
5,6920E-02	9,5120E-03
3,9240E-02	7,9710E-04

Thermistor Characteristics

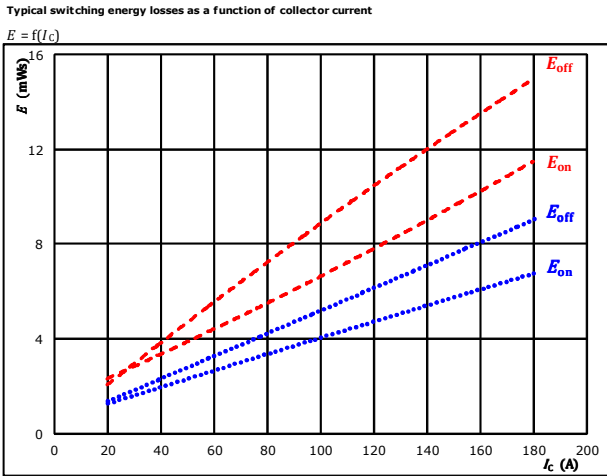
figure 1. Thermistor
Typical NTC characteristic as a function of temperature





Inverter Switching Characteristics

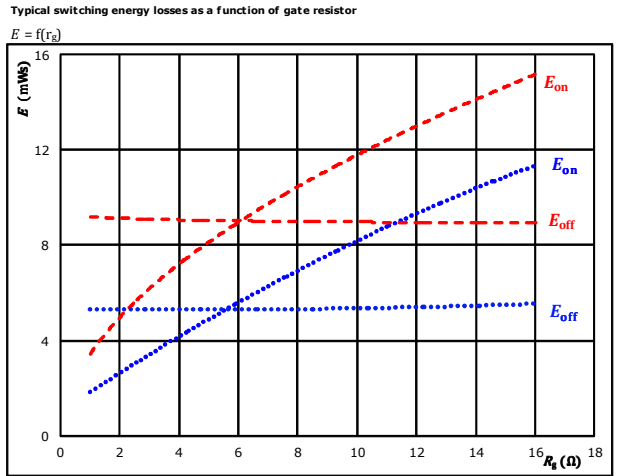
Figure 1. IGBT



With an inductive load at

$V_{CE} = 600$ V	$T_j: 25$ °C
$V_{GE} = \pm 15$ V	125 °C	————
$R_{g(on)} = 4$ Ω	150 °C	-----
$R_{g(off)} = 4$ Ω		

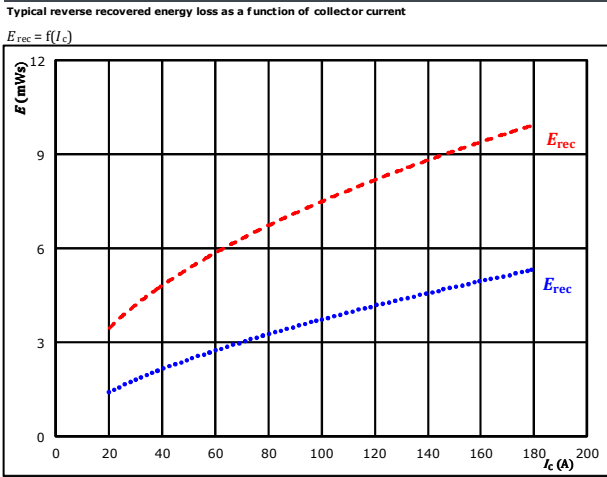
Figure 2. IGBT



With an inductive load at

$V_{CE} = 600$ V	$T_j: 25$ °C
$V_{GE} = \pm 15$ V	125 °C	————
$I_C = 100$ A	150 °C	-----

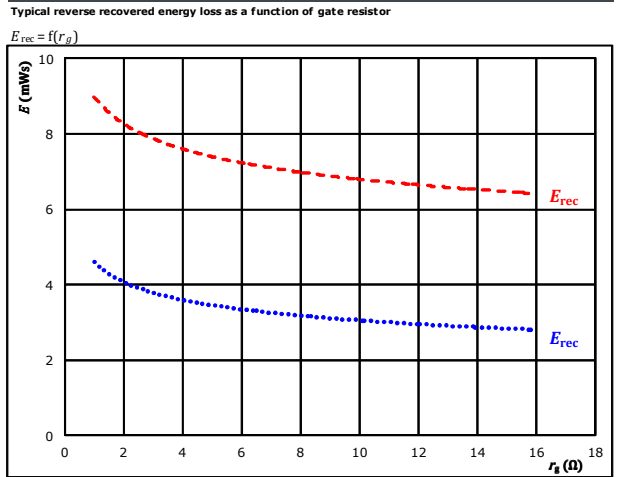
Figure 3. FWD



With an inductive load at

$V_{CE} = 600$ V	$T_j: 25$ °C
$V_{GE} = \pm 15$ V	125 °C	————
$R_{g(on)} = 4$ Ω	150 °C	-----

Figure 4. FWD



With an inductive load at

$V_{CE} = 600$ V	$T_j: 25$ °C
$V_{GE} = \pm 15$ V	125 °C	————
$I_C = 100$ A	150 °C	-----

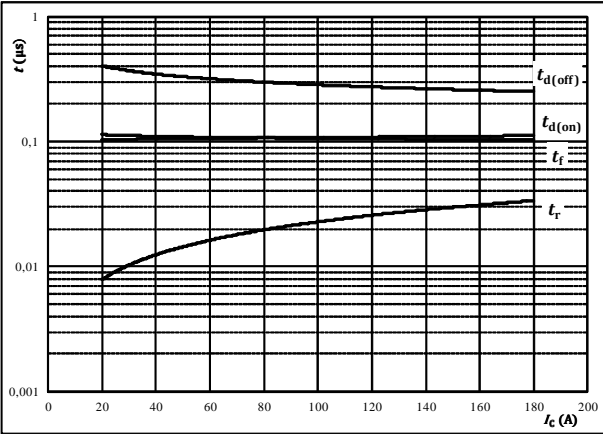


Inverter Switching Characteristics

Figure 5. IGBT

Typical switching times as a function of collector current

$$t = f(I_C)$$



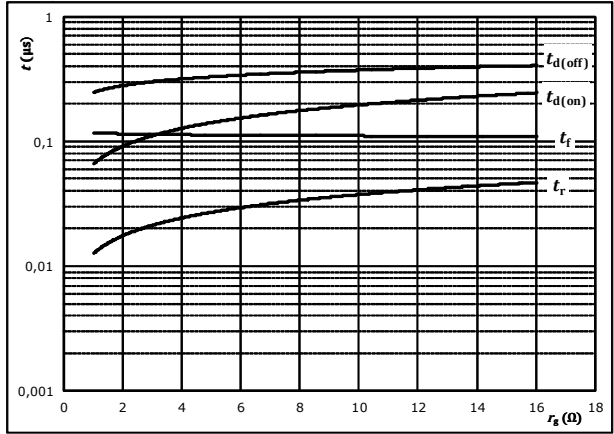
With an inductive load at

$T_j =$	150	$^{\circ}C$
$V_{CE} =$	600	V
$V_{GE} =$	± 15	V
$R_{gon} =$	4	Ω
$R_{goff} =$	4	Ω

Figure 6. IGBT

Typical switching times as a function of gate resistor

$$t = f(r_g)$$



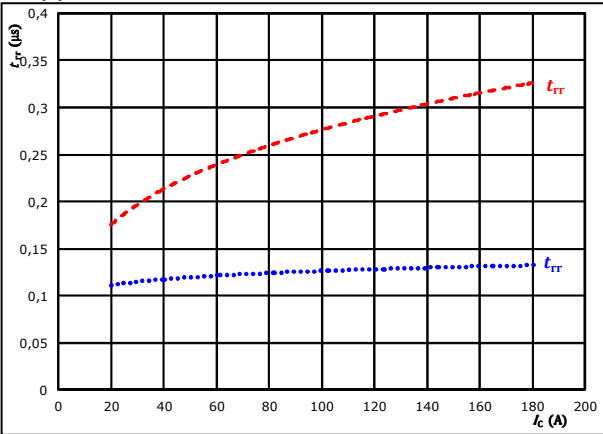
With an inductive load at

$T_j =$	150	$^{\circ}C$
$V_{CE} =$	600	V
$V_{GE} =$	± 15	V
$I_C =$	100	A

Figure 7. FWD

Typical reverse recovery time as a function of collector current

$$t_{rr} = f(I_C)$$

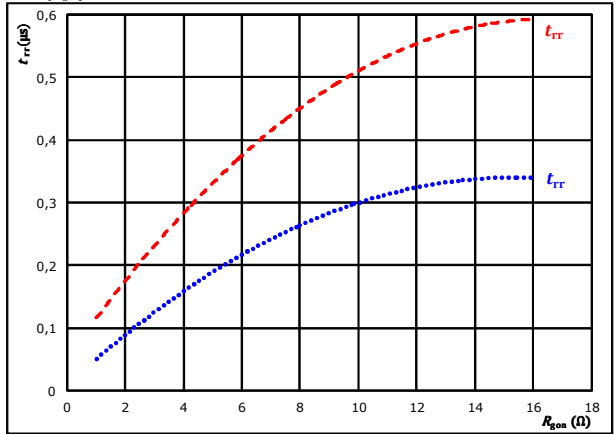


At	$V_{CE} =$	600	V	$T_j:$	25 $^{\circ}C$
	$V_{GE} =$	± 15	V		125 $^{\circ}C$	————
	$R_{gon} =$	4	Ω		150 $^{\circ}C$	-----

Figure 8. FWD

Typical reverse recovery time as a function of IGBT turn on gate resistor

$$t_{rr} = f(R_{gon})$$



At	$V_{CE} =$	600	V	$T_j:$	25 $^{\circ}C$
	$V_{GE} =$	± 15	V		125 $^{\circ}C$	————
	$I_C =$	100	A		150 $^{\circ}C$	-----

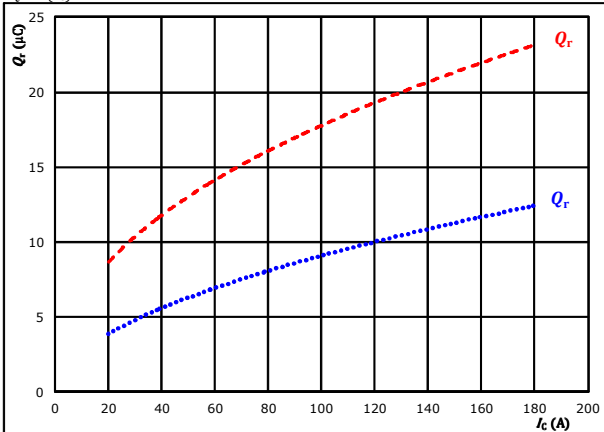


Inverter Switching Characteristics

Figure 9. FWD

Typical recovered charge as a function of collector current

$$Q_r = f(I_c)$$

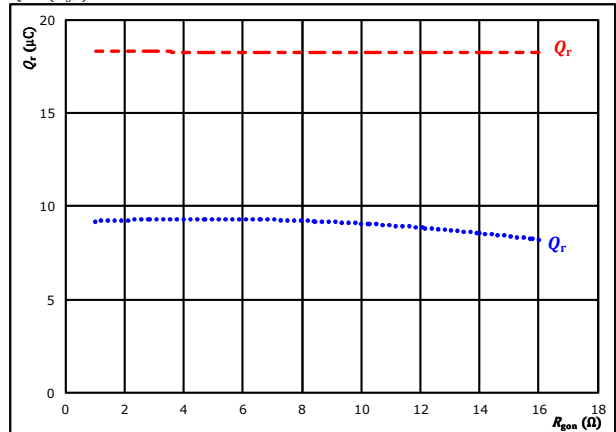


At $V_{CE} = 600$ V $T_j = 25$ °C (blue dotted line)
 $V_{GE} = \pm 15$ V $T_j = 125$ °C (black solid line)
 $R_{gpn} = 4$ Ω $T_j = 150$ °C (red dashed line)

Figure 10. FWD

Typical recovered charge as a function of IGBT turn on gate resistor

$$Q_r = f(R_{gpn})$$

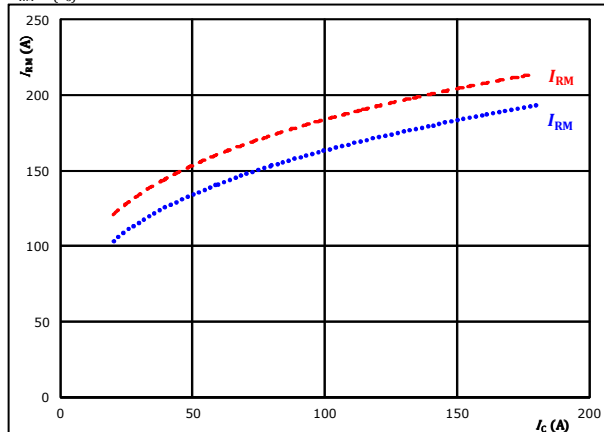


At $V_{CE} = 600$ V $T_j = 25$ °C (blue dotted line)
 $V_{GE} = \pm 15$ V $T_j = 125$ °C (black solid line)
 $I_c = 100$ A $T_j = 150$ °C (red dashed line)

Figure 11. FWD

Typical peak reverse recovery current as a function of collector current

$$I_{RM} = f(I_c)$$

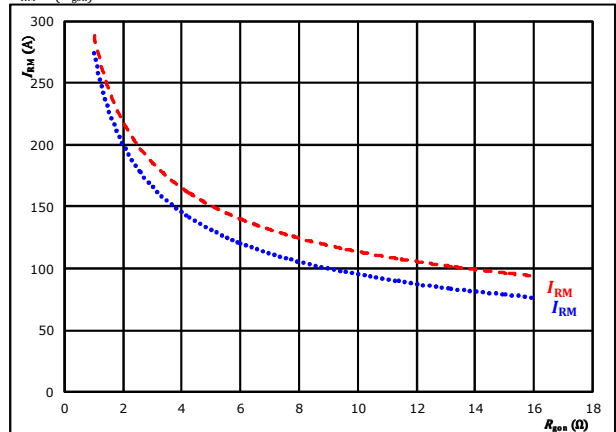


At $V_{CE} = 600$ V $T_j = 25$ °C (blue dotted line)
 $V_{GE} = \pm 15$ V $T_j = 125$ °C (black solid line)
 $R_{gpn} = 4$ Ω $T_j = 150$ °C (red dashed line)

Figure 12. FWD

Typical peak reverse recovery current as a function of IGBT turn on gate resistor

$$I_{RM} = f(R_{gpn})$$



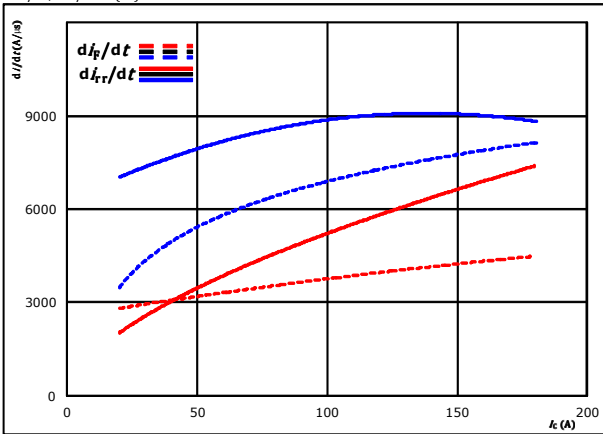
At $V_{CE} = 600$ V $T_j = 25$ °C (blue dotted line)
 $V_{GE} = \pm 15$ V $T_j = 125$ °C (black solid line)
 $I_c = 100$ A $T_j = 150$ °C (red dashed line)



Inverter Switching Characteristics

Figure 13. FWD

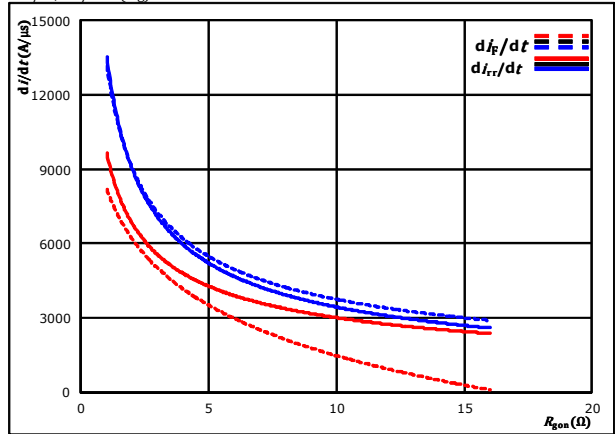
Typical rate of fall of forward and reverse recovery current as a function of collector current
 $di_f/dt, di_{rr}/dt = f(I_c)$



At $V_{CE} = 600$ V $T_j = 25$ °C (dotted line)
 $V_{GE} = \pm 15$ V $T_j = 125$ °C (solid line)
 $R_{gon} = 4$ Ω $T_j = 150$ °C (dashed line)

Figure 14. FWD

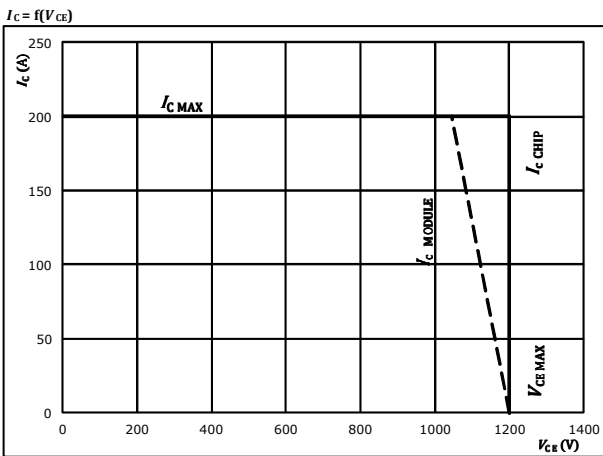
Typical rate of fall of forward and reverse recovery current as a function of IGBT turn on gate resistor
 $di_f/dt, di_{rr}/dt = f(R_{gon})$



At $V_{CE} = 600$ V $T_j = 25$ °C (dotted line)
 $V_{GE} = \pm 15$ V $T_j = 125$ °C (solid line)
 $I_c = 100$ A $T_j = 150$ °C (dashed line)

Figure 15. IGBT

Reverse bias safe operating area



At $T_j = 175$ °C
 $R_{gon} = 4$ Ω
 $R_{goff} = 4$ Ω



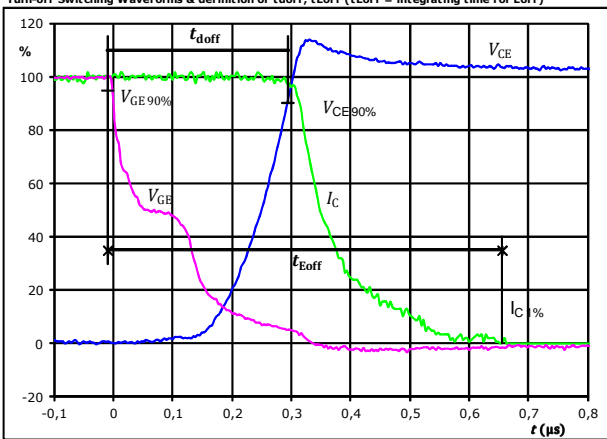
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Inverter Switching Definitions

General conditions

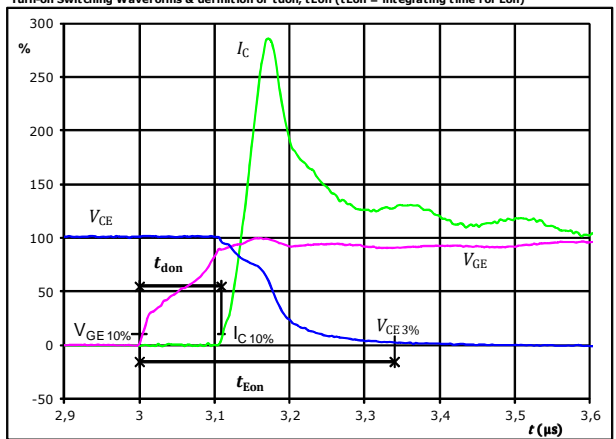
T_j	=	150 °C
R_{gon}	=	4 Ω
R_{goff}	=	4 Ω

Figure 1. IGBT
Turn-off Switching Waveforms & definition of t_{doff} , t_{Eoff} (t_{Eoff} = integrating time for E_{off})



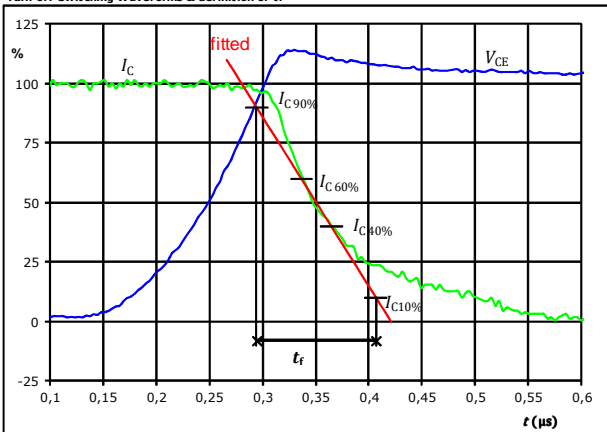
$V_{GE}(0\%) =$	-15	V
$V_{GE}(100\%) =$	15	V
$V_C(100\%) =$	600	V
$I_C(100\%) =$	100	A
$t_{doff} =$	0,293	μs
$t_{Eoff} =$	0,665	μs

Figure 2. IGBT
Turn-on Switching Waveforms & definition of t_{don} , t_{Eon} (t_{Eon} = integrating time for E_{on})



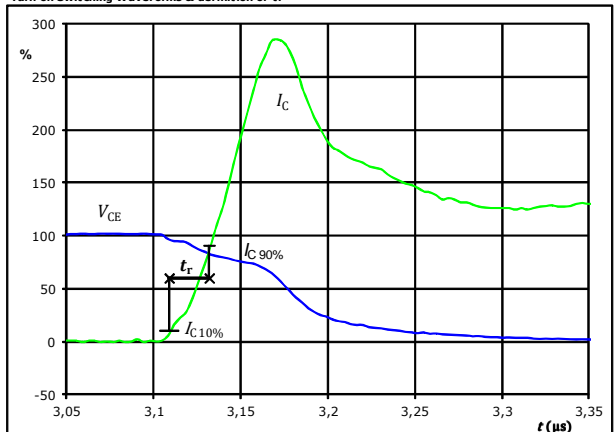
$V_{GE}(0\%) =$	-15	V
$V_{GE}(100\%) =$	15	V
$V_C(100\%) =$	600	V
$I_C(100\%) =$	100	A
$t_{don} =$	0,108	μs
$t_{Eon} =$	0,339	μs

Figure 3. IGBT
Turn-off Switching Waveforms & definition of t_f



$V_C(100\%) =$	600	V
$I_C(100\%) =$	100	A
$t_f =$	0,111	μs

Figure 4. IGBT
Turn-on Switching Waveforms & definition of t_r



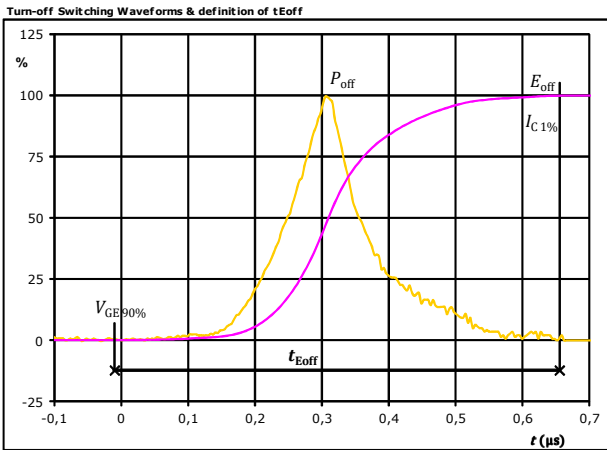
$V_C(100\%) =$	600	V
$I_C(100\%) =$	100	A
$t_r =$	0,023	μs



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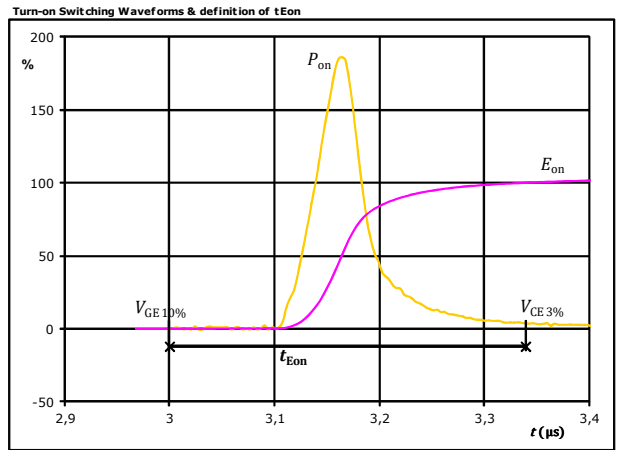
Inverter Switching Characteristics

Figure 5. IGBT



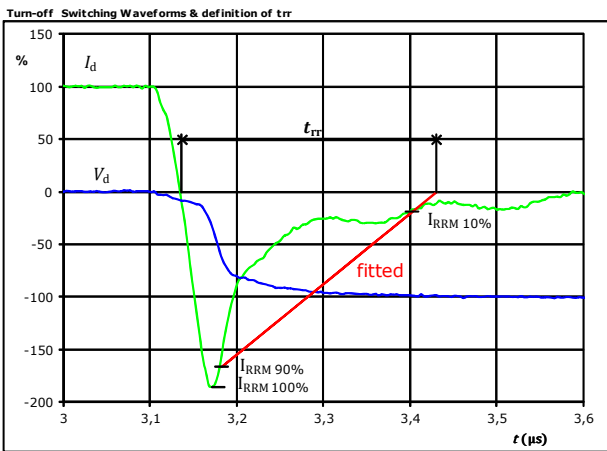
$P_{off}(100\%) = 60,25$ kW
 $E_{off}(100\%) = 8,77$ mJ
 $t_{Eoff} = 0,67$ μs

Figure 6. IGBT



$P_{on}(100\%) = 60,25$ kW
 $E_{on}(100\%) = 6,73$ mJ
 $t_{Eon} = 0,34$ μs

Figure 7. FWD



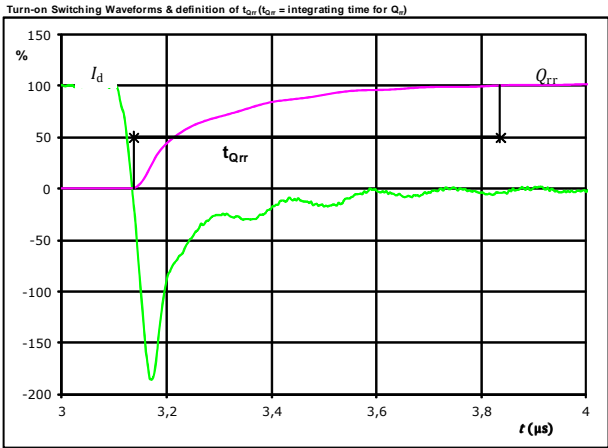
$V_d(100\%) = 600$ V
 $I_d(100\%) = 100$ A
 $I_{RRM}(100\%) = -187$ A
 $t_{rr} = 0,294$ μs



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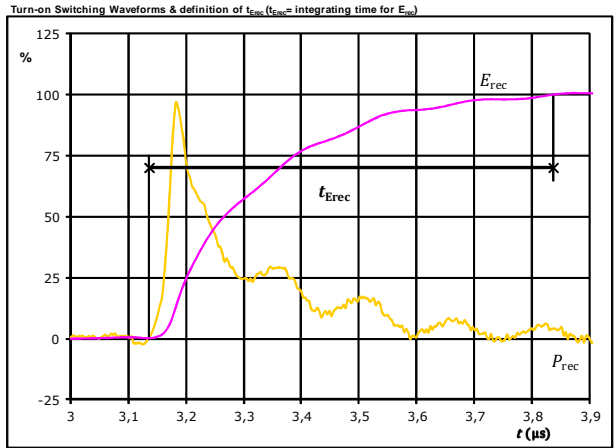
Inverter Switching Characteristics

Figure 8. FWD



I_d (100%) =	100	A
Q_{rr} (100%) =	18,66	μC
t_{Qrr} =	0,70	μs

Figure 9. FWD



P_{rec} (100%) =	60,25	kW
E_{rec} (100%) =	7,96	mJ
t_{Erec} =	0,70	μs



Vincotech

Ordering Code & Marking							
Version			Ordering Code				
with thermal paste 17 mm housing with press-fit pins			30-P2126PA100SC-L289F09Y-/3/				
without thermal paste 17 mm housing with press-fit pins			30-P2126PA100SC-L289F09Y				
NN-NNNNNNNNNNNN TTTTIVVWWYY UL VIN LLLLL SSSS			Name	Date code	UL & VIN	Lot	Serial
Text			NN-NNNNNNNNNNNN-TTTTIVV	WWYY	UL VIN	LLLLL	SSSS
Datamatrix		Type&Ver	Lot number	Serial	Date code		
		TTTTTIVV	LLLLL	SSSS	WWYY		

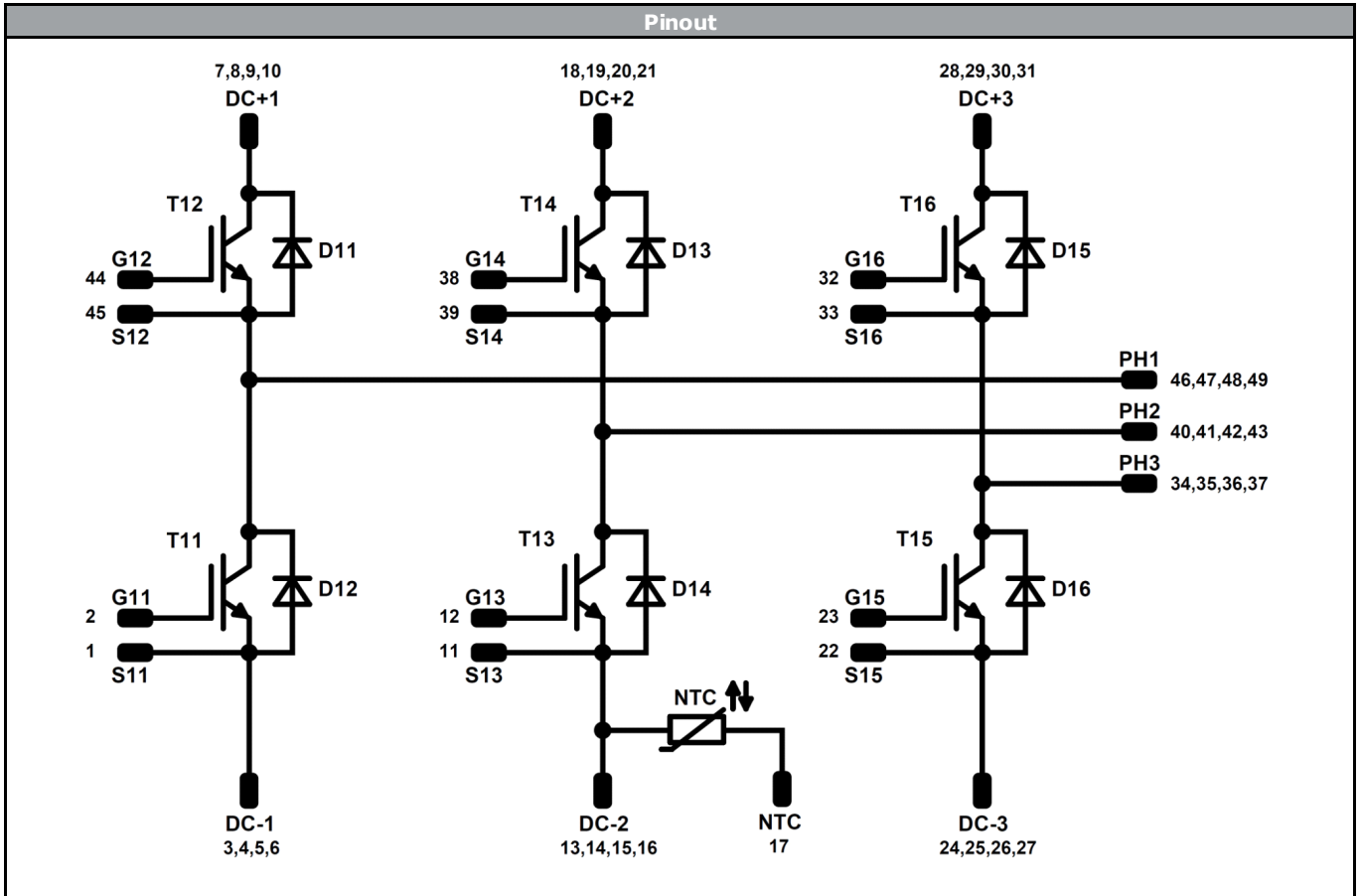
Pin table			
Pin	X	Y	Function
1	0,9	0	S11
2	0,9	3	G11
3	3,9	0	DC-1
4	3,9	2,7	DC-1
5	3,9	5,4	DC-1
6	6,6	0	DC-1
7	15,2	0	DC+1
8	15,2	2,7	DC+1
9	17,9	0	DC+1
10	17,9	2,7	DC+1
11	26,2	0	S13
12	26,2	3	G13
13	29,2	0	DC-2
14	29,2	2,7	DC-2
15	29,2	5,4	DC-2
16	31,9	0	DC-2
17	32,2	4,05	NTC
18	40,5	0	DC+2
19	40,5	2,7	DC+2
20	43,2	0	DC+2
21	43,2	2,7	DC+2
22	51,5	0	S15
23	51,5	3	G15
24	54,5	0	DC-3
25	54,5	2,7	DC-3
26	54,5	5,4	DC-3
27	57,2	0	DC-3
28	65,8	0	DC+3
29	65,8	2,7	DC+3
30	68,5	0	DC+3
31	68,5	2,7	DC+3
32	64,7	36	G16
33	61,7	36	S16
34	58,7	36	PH3
35	56	36	PH3
36	53,3	36	PH3
37	50,6	36	PH3
38	39,4	36	G14
39	36,4	36	S14
40	33,4	36	PH2
41	30,7	36	PH2
42	28	36	PH2
43	25,3	36	PH2
44	14,1	36	G12
45	11,1	36	S12
46	8,1	36	PH1
47	5,4	36	PH1
48	2,7	36	PH1
49	0	36	PH1

Outline

Tolerance of pinpositions: ±0,5 mm at the end of pins
Dimension of coordinate axis is only offset without tolerance



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Identification					
ID	Component	Voltage	Current	Function	Comment
T11, T12, T13, T14, T15, T16	IGBT	1200 V	100 A	Inverter Switch	
D11, D12, D13, D14, D15, D16	FWD	1200 V	100 A	Inverter Diode	
NTC	NTC			Thermistor	




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Packaging instruction			
Standard packaging quantity (SPQ) 36	>SPQ	Standard	<SPQ Sample

Handling instruction
Handling instructions for <i>flow 2</i> packages see vincotech.com website.

Package data
Package data for <i>flow 2</i> packages see vincotech.com website.

UL recognition and file number
This device is certified according to UL 1557 standard, UL file number E192116. For more information see vincotech.com website. 

Document No.:	Date:	Modification:	Pages
30-P2126PA100SC-L289F09Y-D3-14	13 Jul. 2017		

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2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.